ANALOG DEVICES

Matched Monolithic Quad Transistor

MAT-04

FEATURES

- **Low Offset Voltage ..... 200μV Max**
- **High Current Gain ..... 400 Min**
- **Excellent Current Gain Match ..... 2% Max**
- **Low Noise Voltage at 100Hz, 1mA ..... 2.5nV/ Hz Max**
- **Excellent Log Conformance ..... rBE = 0.6Ω Max**
- **Matching Guaranteed for All Transistors**
- **Available in Die Form**

ORDERING INFORMATION †

T_A = +25°C V_{OS} MAX (μV)	PACKAGE		OPERATING TEMPERATURE RANGE
	CERDIP 14-PIN	PLASTIC 14-PIN	
200	MAT04AY*	—	MIL
200	MAT04EY	—	IND
400	MAT04BY*	—	MIL
400	MAT04FY	MAT04FP	XIND
400	—	MAT04FS††	XIND

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.

† Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.

†† For availability and burn-in information on SO and PLCC packages, contact your local sales office.

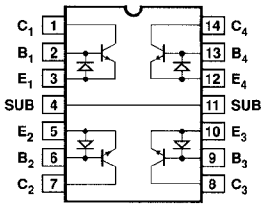
GENERAL DESCRIPTION

The MAT-04 is a quad monolithic NPN transistor that offers excellent parametric matching for precision amplifier and non-linear circuit applications. Performance characteristics of the MAT-04 include high gain (400 minimum) over a wide range of collector current, low noise (2.5nV/$\sqrt{Hz}$ maximum at 100Hz, I_C = 1 mA) and excellent logarithmic conformance. The MAT-04 also features a low offset voltage of 200μV and tight current gain matching, to within 2%. Each transistor of the MAT-04 is individually tested to data sheet specifications. For matching parameters (offset voltage, input offset current, and gain match), each of the dual transistor combinations are verified to meet stated limits. Device performance is guaranteed at 25°C and over the industrial and military temperature ranges.

The long-term stability of matching parameters is guaranteed by the protection diodes across the base-emitter junction of each transistor. These diodes prevent degradation of beta and matching characteristics due to reverse bias base-emitter current.

The superior logarithmic conformance and accurate matching characteristics of the MAT-04 makes it an excellent choice for use in log and antilog circuits. The MAT-04 is an ideal choice in applications where low noise and high gain are required.

PIN CONNECTIONS



14-PIN CERDIP (Y-Suffix)

14-PIN PLASTIC DIP (P-Suffix)

14-PIN SO (S-Suffix)

ABSOLUTE MAXIMUM RATINGS (Note 1)

Collector-Base Voltage (BV_{CBO}) 40V
Collector-Emitter Voltage (BV_{CEO}) 40V
Collector-Collector Voltage (BV_{CC}) 40V
Emitter-Emitter Voltage (BV_{EE}) 40V
Collector Current 30mA
Emitter Current 30mA
Substrate (Pin-4 to Pin-11) Current 30mA
Operating Temperature Range
MAT-04AY, BY ..... –55°C TO +125°C
MAT-04EY ..... –25°C TO +85°C
MAT-04FY,FP,FS ..... –40°C to +85°C
Storage Temperature
Y Package ..... –65°C to +150°C
P Package ..... –65°C to +125°C
Lead Temperature (Soldering, 60 sec) ..... +300°C

PACKAGE TYPE	Θ_{jA} (Note 2)	Θ_{jC}	UNITS
14-Pin CERDIP (Y)	108	16	°C/W
14-Pin Plastic DIP (P)	83	39	°C/W
14-Pin SO (S)	120	36	°C/W

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. Θ_{jA} is specified for worst case mounting conditions, i.e., Θ_{jA} is specified for device in socket for CerDIP and P-DIP packages; Θ_{jA} is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at T_A = 25°C unless otherwise noted. Each transistor is individually tested. For matching parameters (V_{OS}, I_{OS}, Δh_{FE}) each dual transistor combination is verified to meet stated limits. All tests made at endpoints unless otherwise noted.

			MAT-04A/E			MAT-04B/F			
PARAMETER	**SYMBOL**	**CONDITIONS**	**MIN**	**TYP**	**MAX**	**MIN**	**TYP**	**MAX**	**UNITS**
Current Gain	h_{FE}	$10\mu A \le I_C \le 1mA$ $0V \le V_{CB} \le 30V$ (Note 1)	400	800	—	300	600	—	
Current Gain Match	Δh_{FE}	$I_C = 100\mu A$ $0V \le V_{CB} \le 30V$ (Note 2)	—	0.5	2	—	1	4	%
Offset Voltage	V_{OS}	$10\mu A \le I_C \le 1mA$ $0V \le V_{CB} \le 30V$ (Note 4)	—	50	200	—	100	400	μV
Offset Voltage Change vs Collector Current	$\Delta V_{OS}/\Delta I_C$	$10\mu A \le I_C \le 1mA$ $V_{CB} = 0V$ (Note 4)	—	5	25	—	10	50	μV
Offset Voltage Change vs V_{CB}	$\Delta V_{OS}/\Delta V_{CB}$	$10\mu A \le I_C \le 1mA$ $0V \le V_{CB} \le 30V$ (Note 4)	—	50	100	—	100	200	μV
Bulk Emitter Resistance	r_{BE}	$10\mu A \le I_C \le 1mA$ $V_{CB} = 0V$ (Note 5)	—	0.4	0.6	—	0.4	0.6	Ω
Input Bias Current	I_B	$I_C = 100\mu A$ $0V \le V_{CB} \le 30V$	—	125	250	—	165	330	nA
Input Offset Current	I_{OS}	$I_C = 100\mu A$ $V_{CB} = 0V$	—	0.6	5	—	2	13	nA
Breakdown Voltage	BV_{CEO}	$I_C = 10\mu A$	40	—	—	40	—	—	V
Collector Saturation Voltage	$V_{CE(SAT)}$	$I_B = 100\mu A$ $I_C = 1mA$	—	0.03	0.06	—	0.03	0.06	V
Collector-Base Leakage Current	I_{CBO}	$V_{CB} = 40V$	—	5	—	—	5	—	pA
Noise Voltage Density	e_n	$V_{CB} = 0V$ $f_O = 10Hz$ $I_C = 1mA$ $f_O = 100Hz$ (Note 3) $f_O = 1kHz$	— — —	2 1.8 1.8	3 2.5 2.5	— — —	2 1.8 1.8	4 3 3	$nV/\sqrt{Hz}$
Gain Bandwidth Product	f_T	$I_C = 1mA$ $V_{CE} = 10V$	—	300	—	—	300	—	MHz
Output Capacitance	C_{OBO}	$V_{CB} = 15V$ $I_E = 0$ $f = 1MHz$	—	10	—	—	10	—	pF
Input Capacitance	C_{EBO}	$V_{BE} = 0V$ $I_C = 0$ $f = 1MHz$	—	40	—	—	40	—	pF

NOTES:

1. Current gain measured at I_C = 10μA, 100μA and 1mA.
2. Current gain match is defined as: $\Delta h_{FE} = \frac{100\,(\Delta I_B)\,(h_{FE}\,min)}{I_C}$
3. Sample tested.
4. Measured at I_C = 10μA and guaranteed by design over the specified range of I_C.
5. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $-25°C \le T_A \le +85°C$ for MAT-04E, $-40°C \le T_A \le +85°C$ for MAT-04F, unless otherwise noted. Each transistor is individually tested. For matching parameters (V_{OS}, I_{OS}) each dual transistor combination is verified to meet stated limits. All tests made at endpoints unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	MAT-04E MIN	MAT-04E TYP	MAT-04E MAX	MAT-04F MIN	MAT-04F TYP	MAT-04F MAX	UNITS
Current Gain	h_{FE}	$10\mu A \le I_C \le 1mA$ $0V \le V_{CB} \le 30V$ (Note 1)	225	625	—	200	500	—	
Offset Voltage	V_{OS}	$10\mu A \le I_C < 1mA$ $0V \le V_{CB} \le 30V$ (Note 3)	—	60	260	—	120	520	μV
Average Offset Voltage Drift	TCV_{OS}	$I_C = 100\mu A$ $V_{CB} = 0V$ (Note 2)	—	0.2	1	—	0.4	2	μV/°C
Input Bias Current	I_B	$I_C = 100\mu A$ $0V \le V_{CB} \le 30V$	—	160	445	—	200	500	nA
Input Offset Current	I_{OS}	$I_C = 100\mu A$ $V_{CB} = 0V$	—	4	20	—	8	40	nA
Average Offset Current Drift	TCI_{OS}	$I_C = 100\mu A$ $V_{CB} = 0V$	—	50	—	—	100	—	pA/°C
Breakdown Voltage	BV_{CEO}	$I_C = 10\mu A$	40	—	—	40	—	—	V
Collector-Base Leakage Current	I_{CBO}	$V_{CB} = 40V$	—	0.5	—	—	0.5	—	nA
Collector-Emitter Leakage Current	I_{CES}	$V_{CE} = 40V$	—	5	—	—	5	—	nA
Collector-Substrate Leakage Current	I_{CS}	$V_{CS} = 40V$	—	0.7	—	—	0.7	—	nA

ELECTRICAL CHARACTERISTICS at $-55°C \le T_A \le 125°C$ unless otherwise noted. Each transistor is individually tested. For matching parameters (V_{OS}, I_{OS}) each dual transistor combination is verified to meet stated limits. All tests made at endpoints unless otherwise noted.

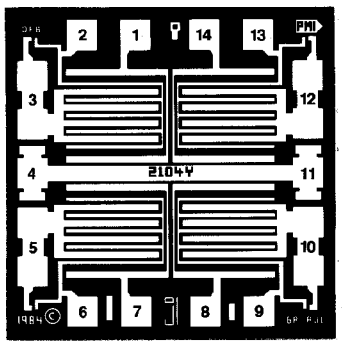
PARAMETER	SYMBOL	CONDITIONS	MAT-04A MIN	MAT-04A TYP	MAT-04A MAX	MAT-04B MIN	MAT-04B TYP	MAT-04B MAX	UNITS
Current Gain	h_{FE}	$10\mu A \le I_C \le 1mA$ $0V \le V_{CB} \le 30V$ (Note 1)	175	475	—	125	425	—	
Offset Voltage	V_{OS}	$10\mu A \le I_C \le 1mA$ $0V \le V_{CB} \le 30V$ (Note 3)	—	70	300	—	140	600	μV
Average Offset Voltage Drift	TCV_{OS}	$I_C = 100\mu A$ $V_{CB} = 0V$ (Note 2)	—	0.2	1	—	0.4	2	μV/°C
Input Bias Current	I_B	$I_C = 100\mu A$ $0V \le V_{CB} \le 30V$	—	210	570	—	235	800	nA
Input Offset Current	I_{OS}	$I_C = 100\mu A$ $V_{CB} = 0V$	—	6	30	—	12	60	nA
Average Offset Current Drift	TCI_{OS}	$I_C = 100\mu A$ $V_{CB} = 0V$	—	50	—	—	100	—	pA/°C
Breakdown Voltage	BV_{CEO}	$I_C = 10\mu A$	40	—	—	40	—	—	V
Collector-Base Leakage Current	I_{CBO}	$V_{CB} = 40V$	—	5	—	—	5	—	nA
Collector-Emitter Leakage Current	I_{CES}	$V_{CE} = 40V$	—	100	—	—	100	—	nA
Collector-Substrate Leakage Current	I_{CS}	$V_{CS} = 40V$	—	7	—	—	7	—	nA

NOTES:

1. Current gain measured at $I_C = 10\mu A$, $100\mu A$ and 1mA.
2. Guaranteed by V_{OS} test ($TCV_{OS} \le V_{OS}/T$ for $V_{OS} << V_{BE}$) T = 298°K for $T_A = 25°C$.
3. Measured at $I_C = 10\mu A$ and guaranteed by design over the specified range of I_C.

MAT-04

DICE CHARACTERISTICS



DIE SIZE 0.060 x 0.060 inch, 3600 sq. mils
(1.52 x 1.52 mm, 2.31 sq. mm)

1. Q_1 COLLECTOR
2. Q_1 BASE
3. Q_1 EMITTER
4. SUBSTRATE
5. Q_2 EMITTER
6. Q_2 BASE
7. Q_2 COLLECTOR
8. Q_3 COLLECTOR
9. Q_3 BASE
10. Q_3 EMITTER
11. SUBSTRATE
12. Q_4 EMITTER
13. Q_4 BASE
14. Q_4 COLLECTOR

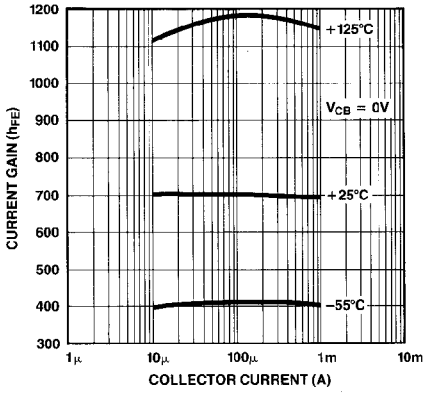
WAFER TEST LIMITS at T_A = +25°C unless otherwise noted. Each transistor is individually tested. For matching parameters (V_{OS}, I_{OS}, Δh_{FE}) each dual transistor combination is verified to meet stated limits. All tests made at endpoints unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	MAT-04N LIMITS	UNITS
Current Gain	h_{FE}	I_C = 100µA 0V ≤ V_{CB} ≤ 30V	300	MIN
Current Gain Match	Δh_{FE}	I_C = 100µA, V_{CB} = 0V	4	% MAX
Offset Voltage	V_{OS}	10µA ≤ I_C ≤ 1mA 0V ≤ V_{CB} ≤ 30V (Note 1)	400	µV MAX
Offset Voltage Change vs Collector Current	$\Delta V_{OS}/\Delta I_C$	10µA ≤ I_C ≤ 1mA V_{CB} = 0V (Note 1)	50	µV MAX
Offset Voltage Change us VCB	$\Delta V_{OS}/\Delta V_{CB}$	10µA ≤ I_C ≤ 1mA 0V ≤ V_{CB} ≤ 30V (Note 1)	200	µV MAX
Bulk Emitter Resistance	r_{BE}	10µA ≤ I_C ≤ 1mA V_{CB} = 0V (Note 2)	0.6	Ω MAX
Collector Saturation Voltage	$V_{CE(SAT)}$	I_B = 100µA I_C = 1mA	0.06	V MAX
Input Bias Current	I_B	I_C = 100µA 0V ≤ V_{CB} ≤ 30V	330	nA MAX
Input Offset Current	I_{OS}	I_C = 100µA V_{CB} = 0V	13	nA MAX
Breakdown Voltage	BV_{CEO}	I_C = 10µA	40	V MIN

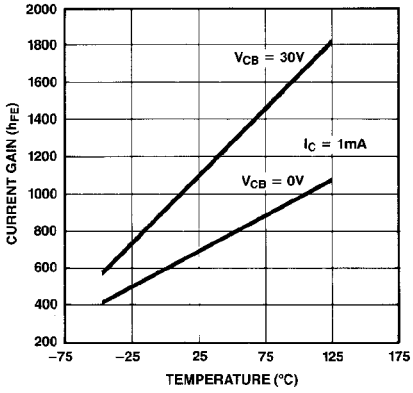
NOTE:
Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

TYPICAL PERFORMANCE CHARACTERISTICS

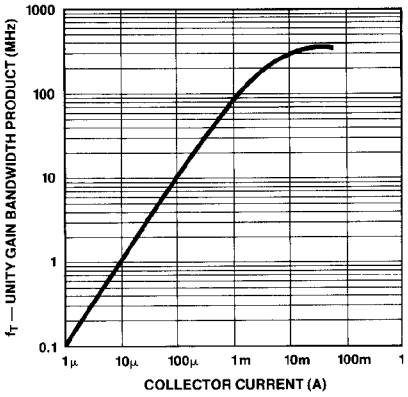
CURRENT GAIN vs COLLECTOR CURRENT



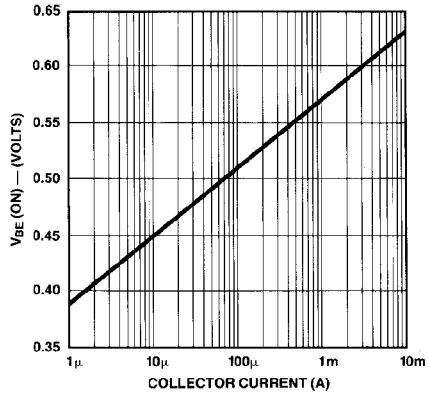
CURRENT GAIN vs TEMPERATURE



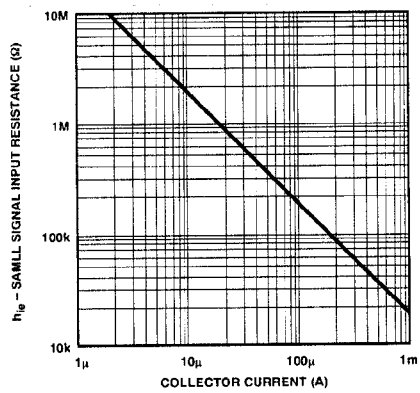
GAIN BANDWIDTH vs COLLECTOR CURRENT



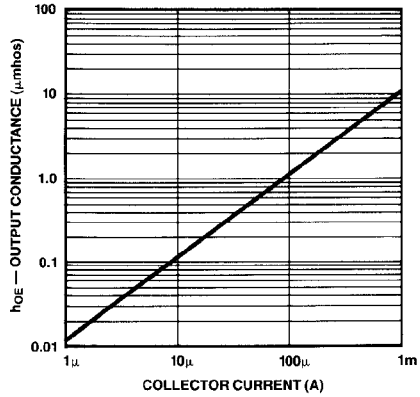
BASE-EMITTER-ON-VOLTAGE vs COLLECTOR CURRENT



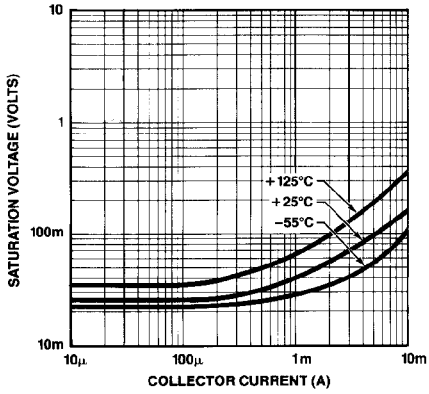
SMALL SIGNAL INPUT RESISTANCE (h_{ie}) vs COLLECTOR CURRENT



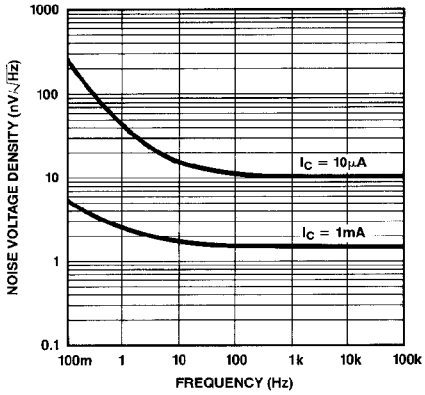
SMALL SIGNAL OUTPUT CONDUCTANCE vs COLLECTOR CURRENT



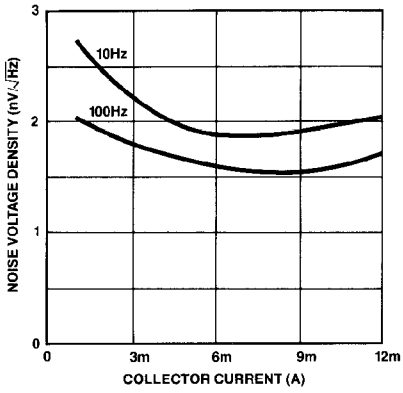
SATURATION VOLTAGE vs COLLECTOR CURRENT



NOISE VOLTAGE DENSITY vs FREQUENCY

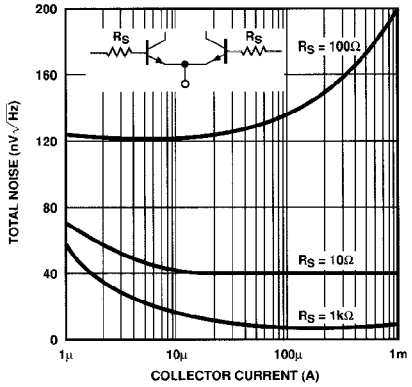


NOISE VOLTAGE DENSITY vs COLLECTOR CURRENT

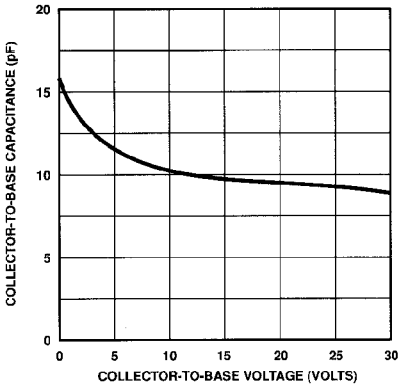


TYPICAL PERFORMANCE CHARACTERISTICS *Continued*

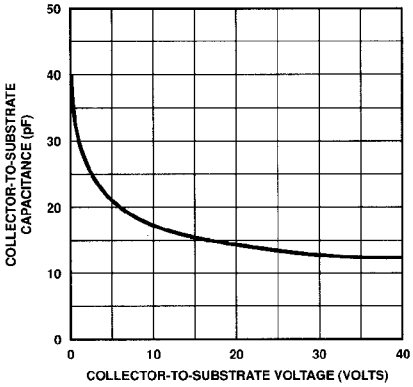
TOTAL NOISE vs COLLECTOR CURRENT



COLLECTOR-TO-BASE CAPACITANCE vs COLLECTOR-TO-BASE VOLTAGE



COLLECTOR-TO-SUBSTRATE CAPACITANCE vs COLLECTOR-TO- SUBSTRATE VOLTAGE



APPLICATION NOTES

It is recommended that one of the substrate pins (Pins 4 and 11) be tied to the most negative circuit potential to minimize coupling between devices. Pins 4 and 11 are internally connected.

APPLICATIONS

CURRENT SOURCES

The MAT-04 can be used to implement a variety of high impedance current mirrors as shown in Figures 1, 2, and 3. These current mirrors can be used as biasing elements and load devices for amplifier stages.

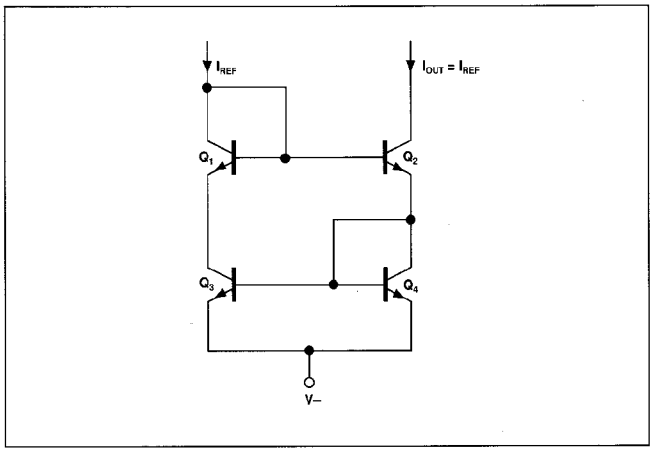


FIGURE 1: *Unity Gain Current Mirror, $I_{OUT} = I_{REF}$*

The unity-gain current mirror of Figure 1, using a MAT-04AY, has an accuracy of better than 1% and an output impedance of over 100MΩ at 100µA. Figures 2 and 3 show modified current mirrors designed for a current gain of two, and one-half respectively. The accuracy of these mirrors is reduced from that of the unity-gain source due to base current errors but is still better than 2%.

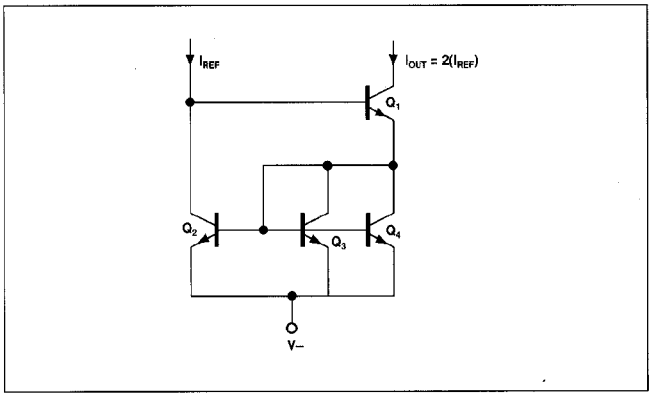


FIGURE 2: *Current Mirror, $I_{OUT} = 2(I_{REF})$*

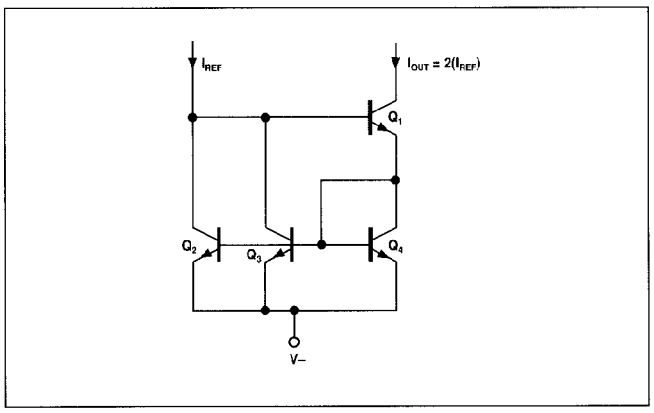
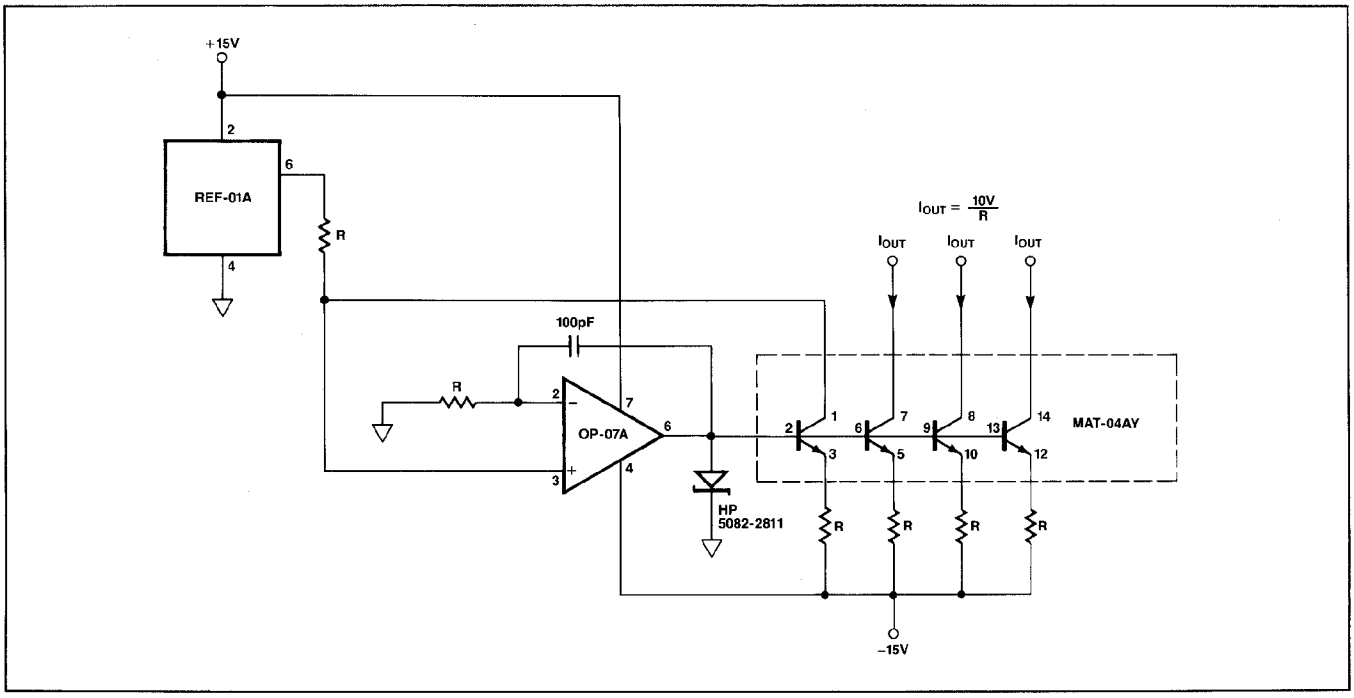


FIGURE 2: *Current Mirror, $I_{OUT} = 2(I_{REF})$*

Figure 4 is a temperature independent current sink that has an accuracy of better than 1% over the military temperature range at an output current of 100µA to 1 mA. The Schottky diode acts as a clamp to insure correct circuit start-up at power on. The resistors used in this circuit should be 1% metal-film type.

FIGURE 4: Temperature Independent Current Sink, $I_{OUT} = 10V/R\Omega$



NONLINEAR FUNCTIONS

An application where precision matched-transistors are a powerful tool is in the generation of nonlinear functions. These circuits are based on the transistor's logarithmic property which takes the following idealized form:

$$V_{BE} = \frac{kT}{q} \ln \frac{I_C}{I_S}$$

The MAT-04, with its excellent logarithmic conformance, maintains this idealized function over many decades of collector current. This, in addition to the stringent parametric matching of the MAT-04, enables the implementation of extremely accurate log/antilog circuits.

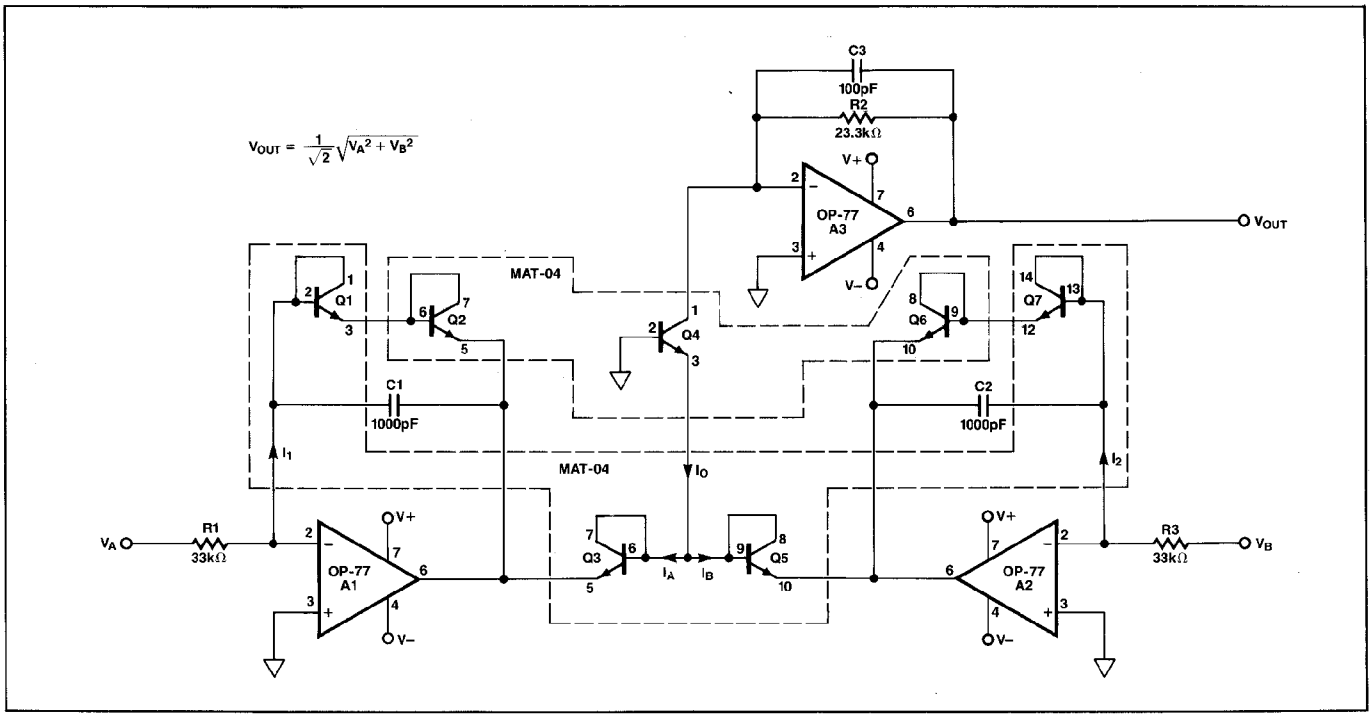
The circuit of Figure 5 is a vector summer that adds and subtracts logged inputs to generate the following transfer function:

$$V_{OUT} = \frac{1}{\sqrt{2}} \sqrt{V_A^2 + V_B^2}$$

This circuit uses two MAT-04AYs and maintains an accuracy of better than 0.5% over an input range of 10mV to 10V. The layout of the MAT-04s reduces errors due to matching and temperature differences between the two precision quad matched-transistors.

Op amps A1 and A2 translate the input voltages into logarithmic valued currents (I_A and I_B in Figure 5) that flow through transistor Q_3 and Q_5. These currents are summed by transistor Q_4 ($I_O = I_A + I_B = \sqrt{I_1^2 + I_2^2}$) which feeds the current-to-voltage converter consisting of op amp A3. To maintain accuracy, 1% metal-film resistors should be used.

FIGURE 5: Vector Summer



LOW NOISE, HIGH SPEED INSTRUMENTATION AMPLIFIER

The circuit of Figure 6 is a very low noise, high speed amplifier, ideal for use in precision transducer and professional audio applications. The performance of the amplifier is summarized in Table I. Figure 7 shows the input referred spot noise over the 0-25kHz bandwidth to be flat at 1.2nV/ $\sqrt{Hz}$. Figure 8 highlights the low 1/f noise corner at 2Hz.

The circuit uses a high speed op amp, the OP-17, preceded by an input amplifier. This consists of a precision dual matched-transistor, the MAT-02, and a feedback V-to-I converter, the MAT-04. The arrangement of the MAT-04 is known as a "linearized cross quad" which performs the voltage-to-current conversion. The OP-17 acts as an overall nulling amplifier to complete the feedback loop. Resistors R1, R2, and R3, R4 form voltage dividers that attenuate the output voltage swing since the "cross quad" arrangement has a limited input range. Biasing for the input stage is set by zener diode Z1. At low currents the effective zener voltage is about 3.3V due to the soft knee characteristic of the zener diode. This results in a bias current of 530μA per side for the input stage. The gain of this amplifier with the values shown in Figure 6 is:

$$\frac{V_{OUT}}{V_{IN}} = \frac{33000}{R_G}$$

TABLE I: Instrumentation Amplifier Characteristics

Input Noise Voltage Density	G = 1000	1.2nV/ $\sqrt{Hz}$
	G = 100	3.6nV/ $\sqrt{Hz}$
	G = 10	30nV/ $\sqrt{Hz}$
Bandwidth	G = 500	400kHz
	G = 100	1MHz
	G = 10	1.2MHz
Slew Rate		40V/μs
Common-Mode Rejection	G = 1000	130dB
Distortion	G = 100 f = 20Hz to 20kHz	0.03%
Settling Time	G = 1000	10μs
Power Consumption		350mW

FIGURE 6: Low Noise, High Speed Instrumentation Amplifier

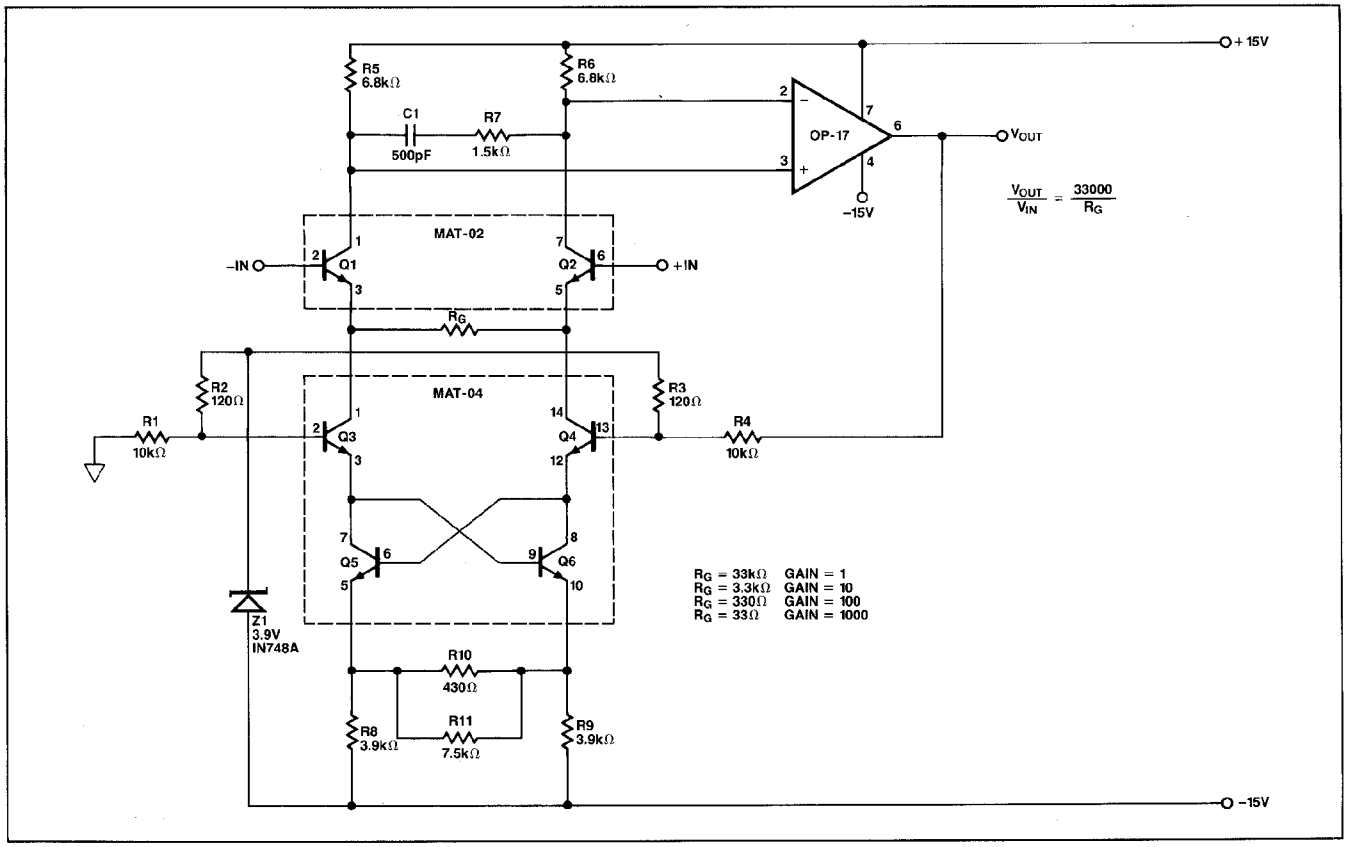
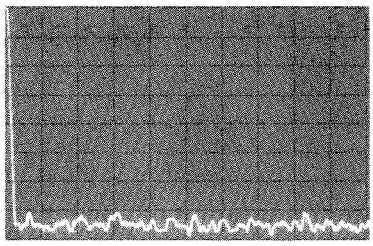
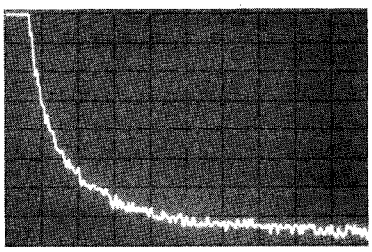


FIGURE 7: Spot Noise of the Instrumentation Amplifier from 0-25kHz at a Gain of 1000



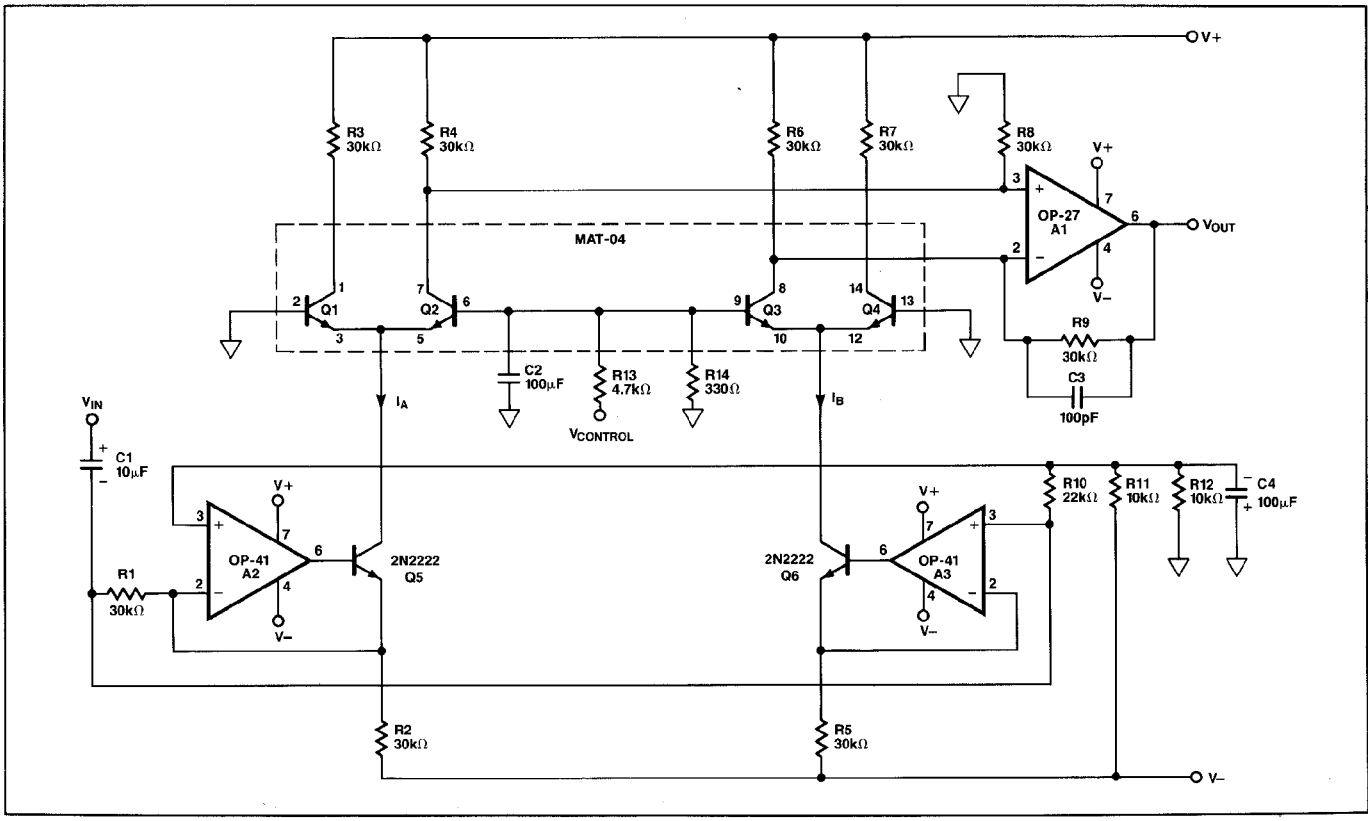
NORMALIZED VERTICAL AXIS = 2.6nV/$\sqrt{\text{Hz}}$ /DIVISION
REFERENCED TO INPUT.
HORIZONTAL AXIS = 0 TO 25kHz.

FIGURE 8: Low Frequency Noise Spectrum Showing Low 2Hz Noise Corner. Gain = 1000.



HORIZONTAL AXIS = 0 TO 5Hz

FIGURE 9: Voltage-Controlled Attenuator



VOLTAGE-CONTROLLED ATTENUATOR

The voltage-controlled attenuator (VCA) of Figure 9, widely used in professional audio circles, can easily be implemented using a MAT-04. The excellent matching characteristics of the MAT-04 enables the VCA to have a distortion level of under 0.03% over a wide range of control voltages. The VCA accepts a 3V RMS input and easily handles the full 20Hz-20kHz audio bandwidth as shown in Figure 10. Noise level for the VCA is more than 110dB below maximum output.

In the voltage-controlled attenuator, the input signal modulates the stage current of each differential pair. Op amps A2 and A3 in conjunction with transistors Q5 and Q6 form voltage-to-current converters that transform a single input voltage into differential currents which form the stage currents of each differential pair. The control voltage shifts the current between each side of the two differential pairs, regulating the signal level reaching the output stage which consists of op amp A1. Figure 11 shows the increase in signal attenuation as the control voltage becomes more negative.

The ideal transfer function for the voltage-controlled attenuator is:

$$V_{OUT}/V_{IN} = \frac{2}{1 + \exp\left((-V_{CONTROL})\left(\frac{R14}{R13 + R14}\right)\Big/\left(\frac{kT}{q}\right)\right)}$$

Where k = Boltzmann constant 1.38×10^{-23} J/°K
T = temperature in °K
q = electronic charge = 1.602×10^{-19}C

From the transfer function it can be seen that the maximum gain of the circuit is 2 (6dB).

To insure best performance, resistors R2 through R7 should be 1% metal film resistors. Since capacitor C2 can see small amounts of reverse bias when the control voltage is positive, it may be prudent to use a nonpolarized tantalum capacitor.

FIGURE 10: Voltage-Controlled Attenuator, Attenuation vs Frequency

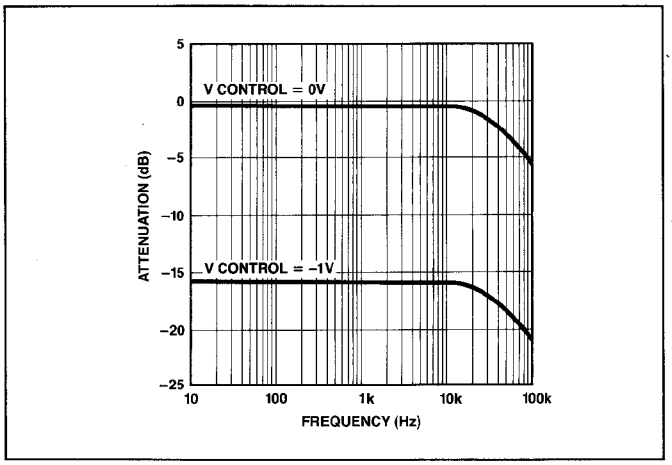


FIGURE 11: Voltage-Controlled Attenuator, Attenuation vs Control Voltage